



DISCRETE POWER DIODES and THYRISTORS
DATA BOOK



SD853C..S50K SERIES

FAST RECOVERY DIODES

Hockey Puk Version

Features

- High power FAST rectifier diode series
- 5.0 μ s recovery time
- High voltage ratings up to 4500V
- High current capability
- Optimized turn on and turn off characteristics
- Low forward recovery
- Fast and soft reverse recovery
- Press-puk encapsulation
- Case style conform to JEDEC DO-200AC (K-PUK)
- Maximum junction temperature 125°C

990A

Typical Applications

- Snubber diode for GTO
- High voltage free-wheeling diode
- Fast recovery rectifier applications



case style DO-200AC (K-PUK)

Major Ratings and Characteristics

Parameters	SD853C..S50K	Units
$I_{F(AV)}$	990	A
@ T_{hs}	55	°C
$I_{F(RMS)}$	1800	A
@ T_{hs}	25	°C
I_{FSM}	19000	A
@ 60Hz	19900	A
I^2t	1810	KA ² s
@ 60Hz	1652	KA ² s
V_{RRM} range	3000 to 4500	V
t_{rr}	5.0	μ s
@ T_J	25	°C
T_J	- 40 to 125	°C

SD853C..S50K Series

ELECTRICAL SPECIFICATIONS

Voltage Ratings

Type number	Voltage Code	V_{RRM} , maximum repetitive peak reverse voltage V	V_{RSM} , maximum non-repetitive peak rev. voltage V	I_{RRM} max. @ $T_J = 125^\circ C$ mA
SD853C..S50K	30	3000	3100	100
	36	3600	3700	
	40	4000	4100	
	45	4500	4600	

Forward Conduction

Parameter	SD853C..S50K	Units	Conditions
$I_{F(AV)}$ Max. average forward current @ Heatsink temperature	990 (420)	A	180° conduction, half sine wave
	55 (85)	°C	Double side (single side) cooled
$I_{F(RMS)}$ Max. RMS forward current	1800	A	@ 25°C heatsink temperature double side cooled
I_{FSM} Max. peak, one-cycle forward, non-repetitive surge current	19000	A	Sinusoidal half wave, Initial $T_J = T_J$ max.
	19900		
	16000		
	16750		
I^2t Maximum I^2t for fusing	1805	KA ² s	Initial $T_J = T_J$ max.
	1645		
	1280		
	1165		
$I^2\sqrt{t}$ Maximum $I^2\sqrt{t}$ for fusing	18050	KA ² \sqrt{s}	$t = 0.1$ to $10ms$, no voltage reapplied
$V_{F(TO)1}$ Low level value of threshold voltage	1.50	V	$(16.7\% \times \pi \times I_{F(AV)} < I < \pi \times I_{F(AV)})$, $T_J = T_J$ max.
$V_{F(TO)2}$ High level value of threshold voltage	1.67		$(I > \pi \times I_{F(AV)})$, $T_J = T_J$ max.
r_{f1} Low level value of forward slope resistance	0.70	mΩ	$(16.7\% \times \pi \times I_{F(AV)} < I < \pi \times I_{F(AV)})$, $T_J = T_J$ max.
r_{f2} High level value of forward slope resistance	0.65		$(I > \pi \times I_{F(AV)})$, $T_J = T_J$ max.
V_{FM} Max. forward voltage drop	2.90	V	$I_{pk} = 2000A$, $T_J = 125^\circ C$, $t_p = 10ms$ sinusoidal wave

Recovery Characteristics

Code	$T_J = 25^\circ C$ typical t_{rr} @ 25% I_{RRM} (μs)	Test conditions			Max. values @ $T_J = 125^\circ C$			
		I_{pk} Square Pulse (A)	di/dt (A/μs)	V_r (V)	t_{rr} @ 25% I_{RRM} (μs)	Q_{rr} (μC)	I_{rr} (A)	
S50	5.0	1000	100	-50	6.5	1000	270	

SD853C..S50K Series

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$I_{F(RMS)}$ Max. RMS forward current	1800	A	@ 25°C heatsink temperature double side cooled
I_{FSM} Max. peak, one-cycle forward, non-repetitive surge current	19000	A	t = 10ms t = 8.3ms t = 10ms t = 8.3ms
	19900		No voltage reapplied
	16000		50% V_{RRM} reapplied
	16750		reapplied
I^2t Maximum I^2t for fusing	1805	KA ² s	Sinusoidal half wave, Initial $T_J = T_J$ max.
	1645		t = 10ms No voltage reapplied
	1280		t = 8.3ms
	1165		t = 10ms 50% V_{RRM} reapplied
$I^2\sqrt{t}$ Maximum $I^2\sqrt{t}$ for fusing	18050	KA ² \sqrt{s}	t = 0.1 to 10ms, no voltage reapplied
	1.50	V	(16.7% $\times \pi \times I_{F(AV)} < I < \pi \times I_{F(AV)}$), $T_J = T_J$ max.
$V_{F(TO)2}$ High level value of threshold voltage	1.67		($I > \pi \times I_{F(AV)}$), $T_J = T_J$ max.
r_{f1} Low level value of forward slope resistance	0.70	mΩ	(16.7% $\times \pi \times I_{F(AV)} < I < \pi \times I_{F(AV)}$), $T_J = T_J$ max.
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Recovery Characteristics

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		I_{pk} Square Pulse (A)	di/dt (*) (A/μs)	V_r (V)	t_{rr} @ 25% I_{RRM} (μs)	Q_{rr} (μC)	I_{rr} (A)	
S50	5.0	1000	100	-50	6.5	1000	270	

SD853C..S50K Series

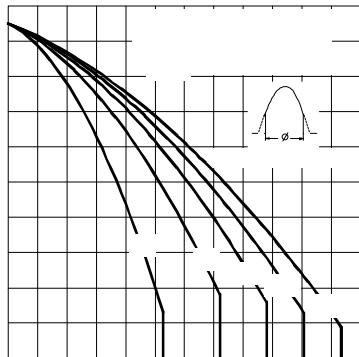


Fig. 3 - Current Ratings Characteristics

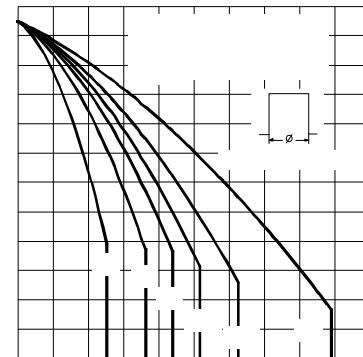


Fig. 4 - Current Ratings Characteristics

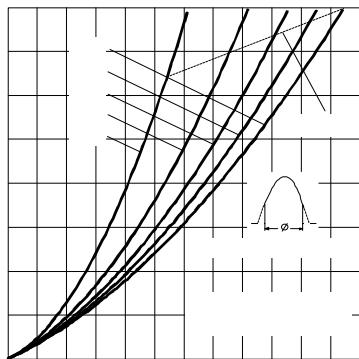


Fig. 5 - Forward Power Loss Characteristics

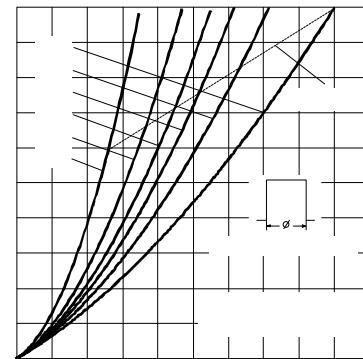


Fig. 6 - Forward Power Loss Characteristics

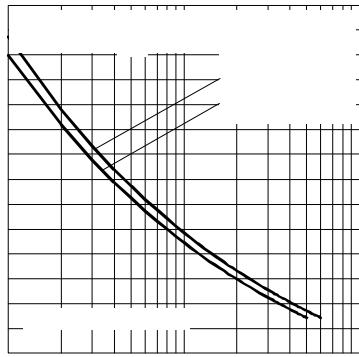


Fig. 7 - Maximum Non-repetitive Surge Current
Single and Double Side Cooled

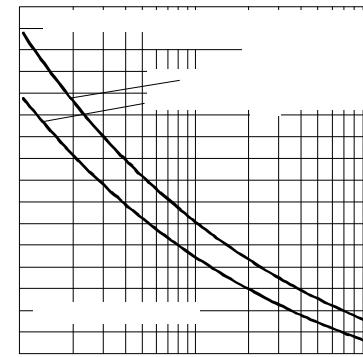


Fig. 8 - Maximum Non-repetitive Surge Current
Single and Double Side Cooled

SD853C..S50K Series

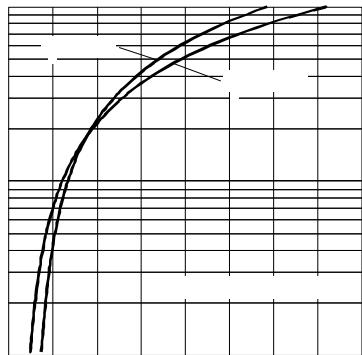


Fig. 9 - Forward Voltage Drop Characteristics

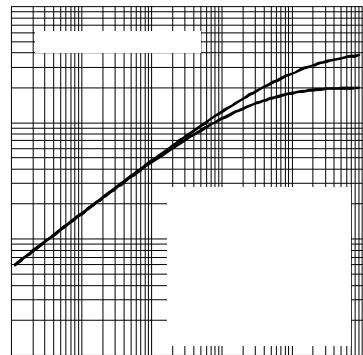


Fig. 10 - Thermal Impedance Z_{thJ-hs} Characteristic

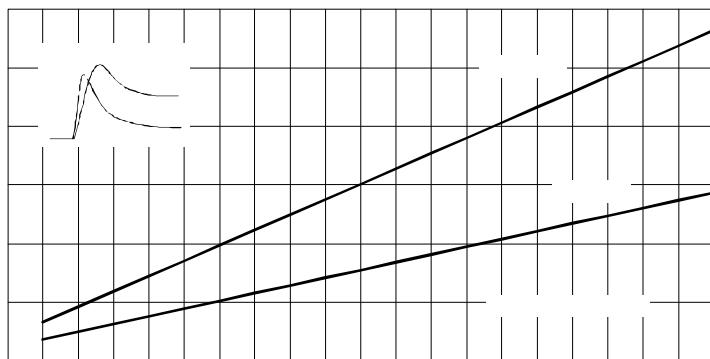


Fig. 11 - Typical Forward Recovery Characteristics

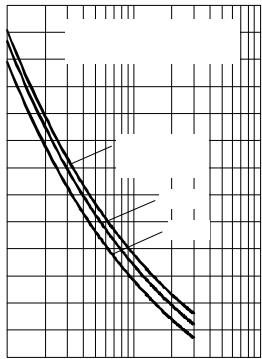


Fig. 12 - Recovery Time Characteristics



Fig. 13 - Recovery Charge Characteristics

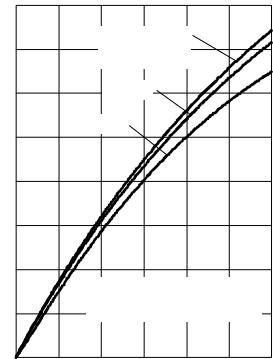


Fig. 14 - Recovery Current Characteristics

SD853C..S50K Series

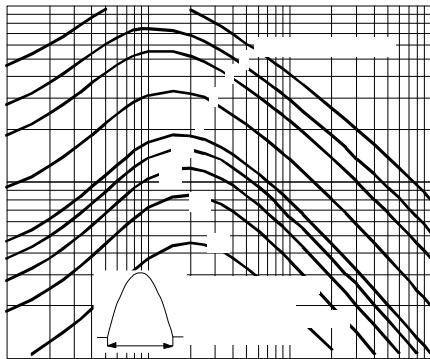


Fig. 15 - Maximum Total Energy Loss Per Pulse Characteristics

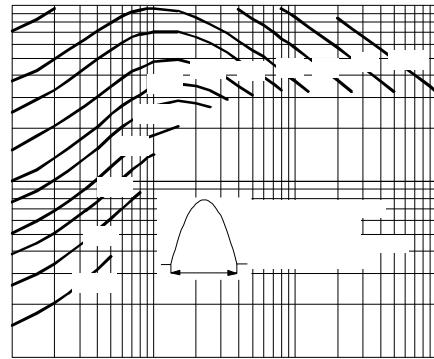


Fig. 16 - Frequency Characteristics

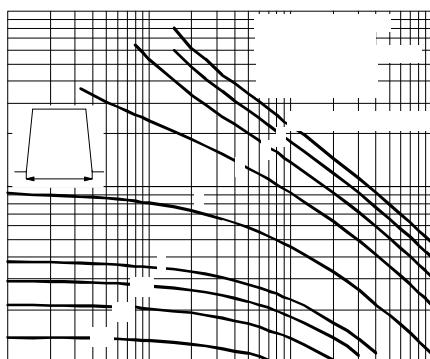


Fig. 17 - Maximum Total Energy Loss Per Pulse Characteristics

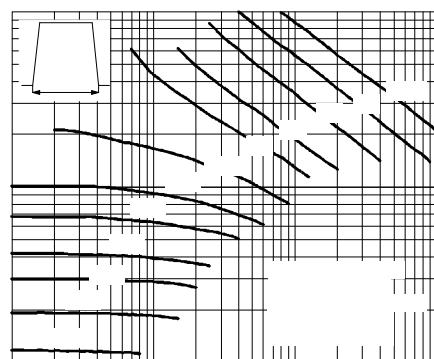


Fig. 18 - Frequency Characteristics

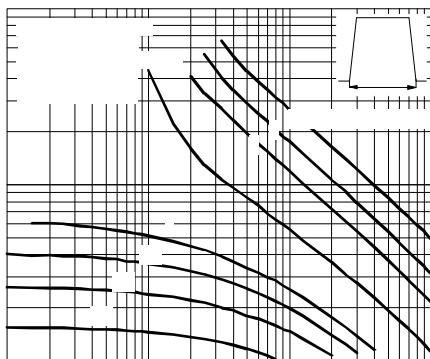


Fig. 19 - Maximum Total Energy Loss Per Pulse Characteristics

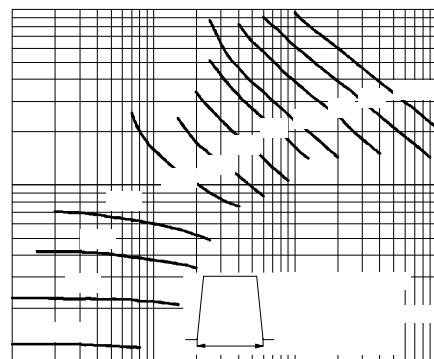


Fig. 20 - Frequency Characteristics

SD853C..S50K Series

Thermal and Mechanical Specifications

Parameter	SD853C..S50K	Units	Conditions
T _J	Max. junction operating temperature range	-40 to 125	°C
T _{stg}	Max. storage temperature range	-40 to 150	
R _{thJ-hs}	Max. thermal resistance, junction to heatsink	0.04 0.02	K/W
F	Mounting force, ± 10%	22250 (2250)	N (Kg)
wt	Approximate weight	425	g
Case style	DO-200AC (K-PUK)	See outline table	

ΔR_{thJ-hs} Conduction

(The following table shows the increment of thermal resistance R_{thJ-hs} when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction		Rectangular conduction		Units	Conditions
	Single Side	Double Side	Single Side	Double Side		
180°	0.0017	0.0019	0.0012	0.0012	K/W	T _J = T _J max.
120°	0.0021	0.0021	0.0021	0.0021		
90°	0.0026	0.0027	0.0029	0.0029		
60°	0.0039	0.0039	0.0041	0.0041		
30°	0.0067	0.0067	0.0068	0.0068		

Ordering Information Table

Device Code		SD	85	3	C	45	S50	K
1	- Diode	1	2	3	4	5	6	7
2	- Essential part number							
3	- 3 = Fast recovery							
4	- C = Ceramic Puk							
5	- Voltage code: Code x 100 = V _{RRM} (See Voltage Ratings table)							
6	- t _{rr} code							
7	- K = Puk Case DO-200AC (K-PUK)							

SD853C..S50K Series

Outline Table

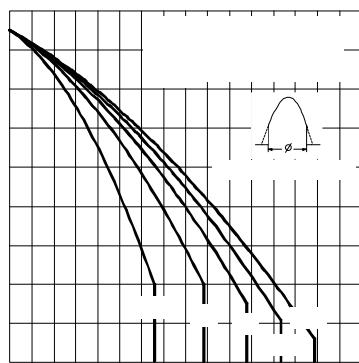
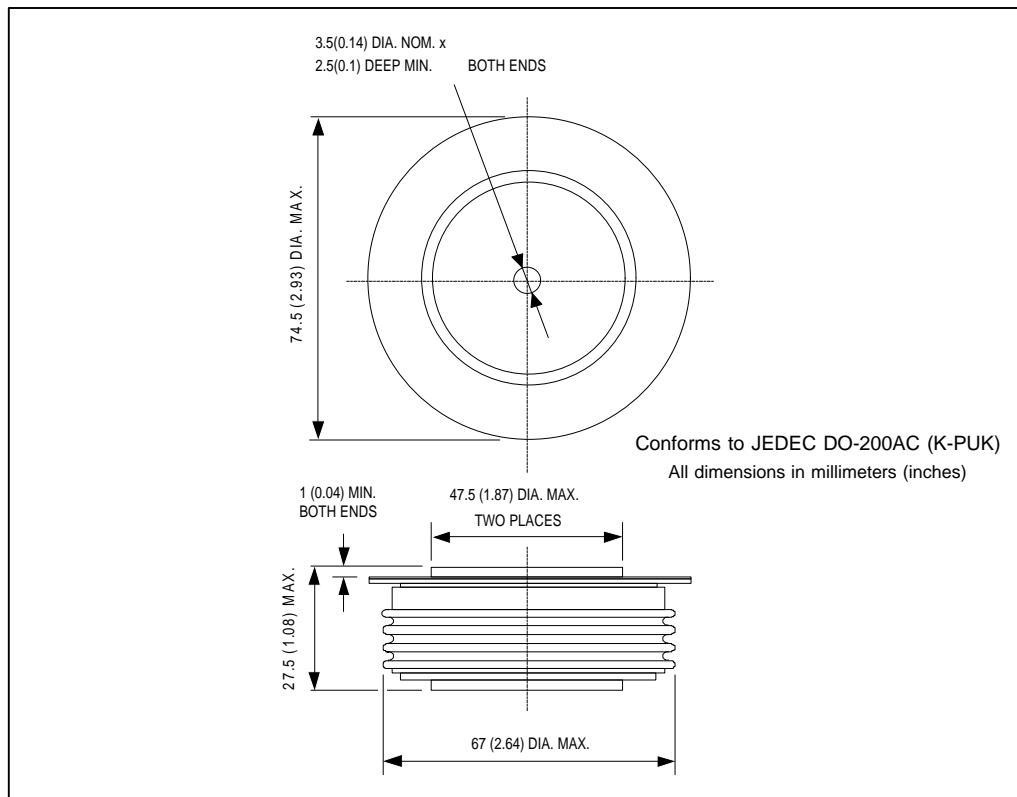


Fig. 1 - Current Ratings Characteristics

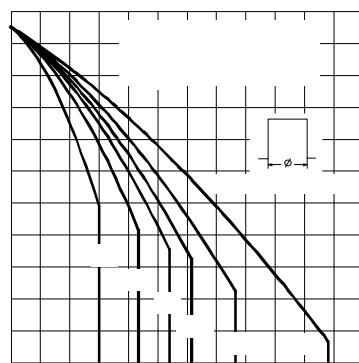


Fig. 2 - Current Ratings Characteristics

SD853C..S50K Series

Thermal and Mechanical Specifications

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T _J	Max. junction operating temperature range	-40 to 125	°C
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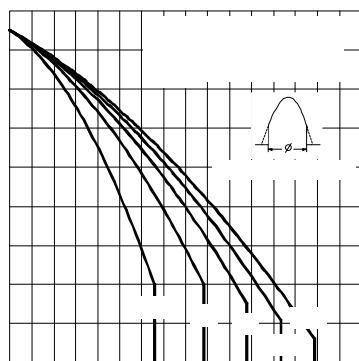
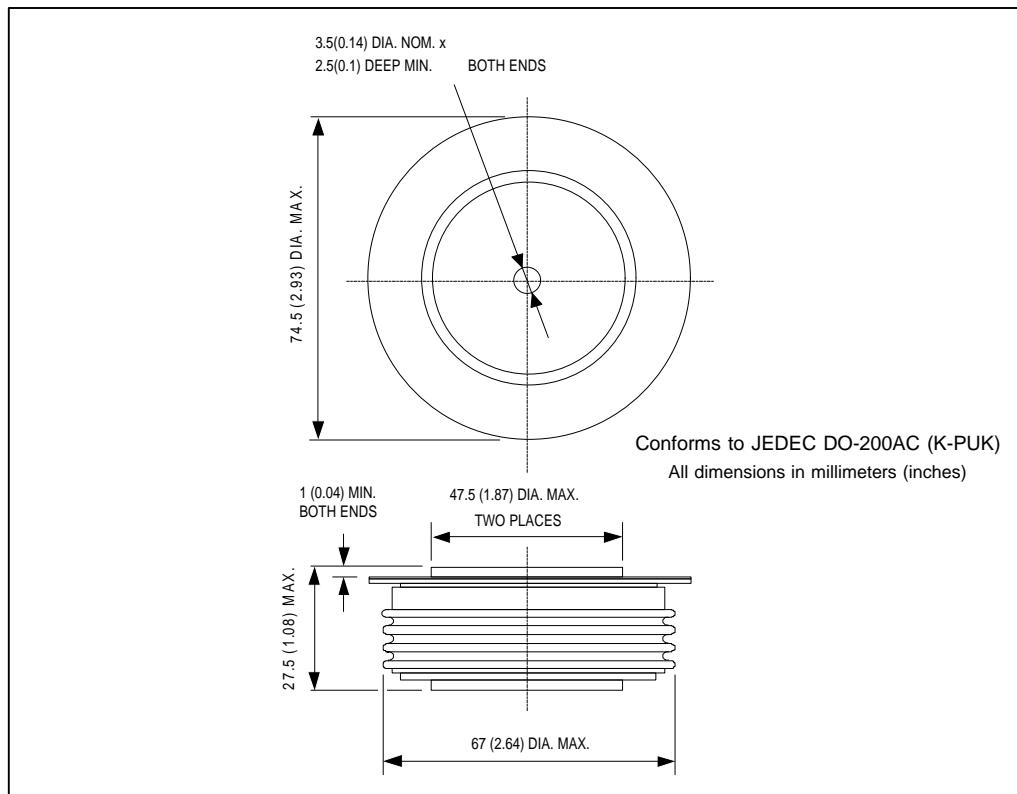


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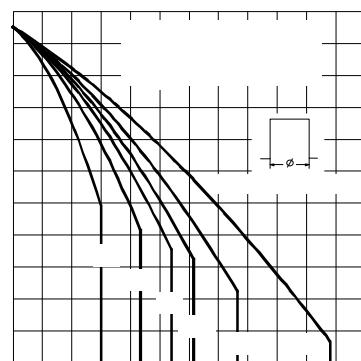


Fig. 2 - Current Ratings Characteristics